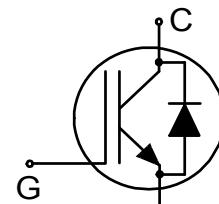


## High speed switching series 5<sup>th</sup> generation

TRENCHSTOP™ 5 high speed soft switching IGBT copacked with full rated current RAPID 1 fast and soft anti parallel diode

### Features and Benefits:

- High speed S5 technology offering
- High speed smooth switching device for hard & soft switching
- Very Low  $V_{CEsat}$
- 650V breakdown voltage
- Low  $Q_G$
- IGBT copacked with full rated current RAPID 1 fast antiparallel diode
- Maximum junction temperature 175°C
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models:  
<http://www.infineon.com/igbt/>



### Potential Applications:

- Drives
- Industrial Power Supplies
  - Industrial SMPS
  - Industrial UPS
- Metal Treatment
  - Welding
- Energy Distribution
  - Energy Storage
- Infrastructure – Charge
  - Charger



### Product Validation:

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

### Key Performance and Package Parameters

Type	$V_{CE}$	$I_C$	$V_{CEsat}, T_{vj}=25^\circ\text{C}$	$T_{vjmax}$	Marking	Package
IKP28N65ES5	650V	28A	1.5V	175°C	K28EES5	PG-T0220-3

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High speed switching series 5<sup>th</sup> generation**Table of Contents**

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## High speed switching series 5<sup>th</sup> generation

### Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_{vj} \geq 25^\circ\text{C}$	$V_{CE}$	650	V
DC collector current, limited by $T_{vjmax}$ $T_c = 25^\circ\text{C}$ $T_c = 100^\circ\text{C}$	$I_C$	38.0 28.0	A
Pulsed collector current, $t_p$ limited by $T_{vjmax}$	$I_{Cpuls}$	90.0	A
Turn off safe operating area $V_{CE} \leq 650\text{V}$ , $T_{vj} \leq 175^\circ\text{C}$ , $t_p = 1\mu\text{s}$	-	90.0	A
Diode forward current, limited by $T_{vjmax}$ $T_c = 25^\circ\text{C}$ value limited by bondwire $T_c = 100^\circ\text{C}$	$I_F$	40.0 27.0	A
Diode pulsed current, $t_p$ limited by $T_{vjmax}$	$I_{Fpuls}$	90.0	A
Gate-emitter voltage Transient Gate-emitter voltage ( $t_p \leq 10\mu\text{s}$ , $D < 0.010$ )	$V_{GE}$	$\pm 20$ $\pm 30$	V
Power dissipation $T_c = 25^\circ\text{C}$ Power dissipation $T_c = 100^\circ\text{C}$	$P_{tot}$	130.0 65.0	W
Operating junction temperature	$T_{vj}$	-40...+175	°C
Storage temperature	$T_{stg}$	-55...+150	°C
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C
Mounting torque, M3 screw Maximum of mounting processes: 3	M	0.6	Nm

### Thermal Resistance

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	

### R<sub>th</sub> Characteristics

IGBT thermal resistance, junction - case	$R_{th(j-c)}$		-	-	1.20	K/W
Diode thermal resistance, junction - case	$R_{th(j-c)}$		-	-	1.50	K/W
Thermal resistance junction - ambient	$R_{th(j-a)}$		-	-	62	K/W

High speed switching series 5<sup>th</sup> generationElectrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Static Characteristic</b>						
Collector-emitter breakdown voltage	$V_{(\text{BR})\text{CES}}$	$V_{\text{GE}} = 0\text{V}, I_{\text{C}} = 0.20\text{mA}$	650	-	-	V
Collector-emitter saturation voltage	$V_{\text{CEsat}}$	$V_{\text{GE}} = 15.0\text{V}, I_{\text{C}} = 28.0\text{A}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 125^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	1.50	1.90	V
Diode forward voltage	$V_F$	$V_{\text{GE}} = 0\text{V}, I_F = 28.0\text{A}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 125^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	1.59	1.95	V
Gate-emitter threshold voltage	$V_{\text{GE}(\text{th})}$	$I_{\text{C}} = 0.28\text{mA}, V_{\text{CE}} = V_{\text{GE}}$	3.2	4.0	4.8	V
Zero gate voltage collector current	$I_{\text{CES}}$	$V_{\text{CE}} = 650\text{V}, V_{\text{GE}} = 0\text{V}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	-	50	$\mu\text{A}$
Gate-emitter leakage current	$I_{\text{GES}}$	$V_{\text{CE}} = 0\text{V}, V_{\text{GE}} = 20\text{V}$	-	-	100	nA
Transconductance	$g_{\text{fs}}$	$V_{\text{CE}} = 20\text{V}, I_{\text{C}} = 28.0\text{A}$	-	29.0	-	S

Electrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Dynamic Characteristic</b>						
Input capacitance	$C_{\text{ies}}$		-	1200	-	
Output capacitance	$C_{\text{oes}}$	$V_{\text{CE}} = 25\text{V}, V_{\text{GE}} = 0\text{V}, f = 1\text{MHz}$	-	38	-	pF
Reverse transfer capacitance	$C_{\text{res}}$		-	5	-	
Gate charge	$Q_G$	$V_{\text{CC}} = 520\text{V}, I_{\text{C}} = 28.0\text{A}, V_{\text{GE}} = 15\text{V}$	-	50.0	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$		-	7.0	-	nH

## Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	

IGBT Characteristic, at  $T_{vj} = 25^\circ\text{C}$ 

Turn-on delay time	$t_{d(\text{on})}$	$T_{vj} = 25^\circ\text{C}, V_{\text{CC}} = 400\text{V}, I_{\text{C}} = 28.0\text{A}, V_{\text{GE}} = 0.0/15.0\text{V}, R_{G(\text{on})} = 34.0\Omega, R_{G(\text{off})} = 34.0\Omega, L_{\sigma} = 30\text{nH}, C_{\sigma} = 30\text{pF}$ $L_{\sigma}, C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	27	-	ns
Rise time	$t_r$		-	28	-	ns
Turn-off delay time	$t_{d(\text{off})}$		-	184	-	ns
Fall time	$t_f$		-	34	-	ns
Turn-on energy	$E_{\text{on}}$		-	0.53	-	mJ
Turn-off energy	$E_{\text{off}}$		-	0.40	-	mJ
Total switching energy	$E_{\text{ts}}$		-	0.93	-	mJ

High speed switching series 5<sup>th</sup> generation

Turn-on delay time	$t_{d(on)}$	$T_{vj} = 25^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 14.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ , $R_{G(on)} = 34.0\Omega$ , $R_{G(off)} = 34.0\Omega$ , $L_\sigma = 30\text{nH}$ , $C_\sigma = 30\text{pF}$ $L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	25	-	ns
Rise time	$t_r$		-	16	-	ns
Turn-off delay time	$t_{d(off)}$		-	193	-	ns
Fall time	$t_f$		-	27	-	ns
Turn-on energy	$E_{on}$		-	0.25	-	mJ
Turn-off energy	$E_{off}$		-	0.15	-	mJ
Total switching energy	$E_{ts}$		-	0.40	-	mJ

Diode Characteristic, at  $T_{vj} = 25^\circ\text{C}$ 

Diode reverse recovery time	$t_{rr}$	$T_{vj} = 25^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 28.0\text{A}$ , $di_F/dt = 1020\text{A}/\mu\text{s}$	-	73	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.60	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	15.5	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-324	-	$\text{A}/\mu\text{s}$
Diode reverse recovery time	$t_{rr}$	$T_{vj} = 25^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 14.0\text{A}$ , $di_F/dt = 1180\text{A}/\mu\text{s}$	-	61	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.40	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	14.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-387	-	$\text{A}/\mu\text{s}$

## Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	

IGBT Characteristic, at  $T_{vj} = 150^\circ\text{C}$ 

Turn-on delay time	$t_{d(on)}$	$T_{vj} = 150^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 28.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ , $R_{G(on)} = 34.0\Omega$ , $R_{G(off)} = 34.0\Omega$ , $L_\sigma = 30\text{nH}$ , $C_\sigma = 30\text{pF}$ $L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	26	-	ns
Rise time	$t_r$		-	28	-	ns
Turn-off delay time	$t_{d(off)}$		-	200	-	ns
Fall time	$t_f$		-	36	-	ns
Turn-on energy	$E_{on}$		-	0.65	-	mJ
Turn-off energy	$E_{off}$		-	0.50	-	mJ
Total switching energy	$E_{ts}$		-	1.15	-	mJ
Turn-on delay time	$t_{d(on)}$	$T_{vj} = 150^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 14.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ , $R_{G(on)} = 34.0\Omega$ , $R_{G(off)} = 34.0\Omega$ , $L_\sigma = 30\text{nH}$ , $C_\sigma = 30\text{pF}$ $L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	25	-	ns
Rise time	$t_r$		-	16	-	ns
Turn-off delay time	$t_{d(off)}$		-	220	-	ns
Fall time	$t_f$		-	48	-	ns
Turn-on energy	$E_{on}$		-	0.35	-	mJ
Turn-off energy	$E_{off}$		-	0.25	-	mJ
Total switching energy	$E_{ts}$		-	0.60	-	mJ

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 High speed switching series 5<sup>th</sup> generation

**Diode Characteristic, at  $T_{vj} = 150^\circ\text{C}$** 

Diode reverse recovery time	$t_{rr}$	$T_{vj} = 150^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 28.0\text{A}$ , $di_F/dt = 830\text{A}/\mu\text{s}$	-	95	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	1.25	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	20.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-395	-	$\text{A}/\mu\text{s}$
Diode reverse recovery time	$t_{rr}$	$T_{vj} = 150^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 14.0\text{A}$ , $di_F/dt = 1020\text{A}/\mu\text{s}$	-	78	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.88	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	18.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-443	-	$\text{A}/\mu\text{s}$

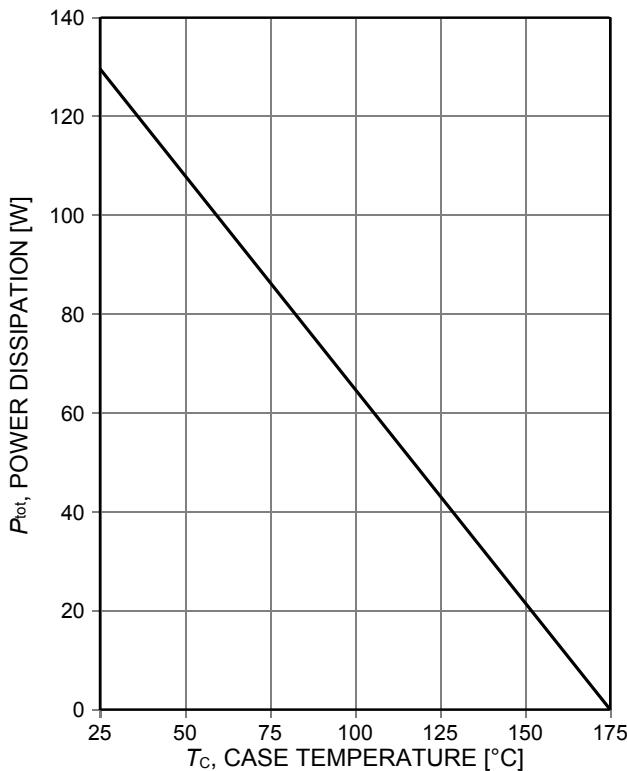
High speed switching series 5<sup>th</sup> generation

Figure 1. Power dissipation as a function of case temperature  
 $(T_{vj} \leq 175^\circ\text{C})$

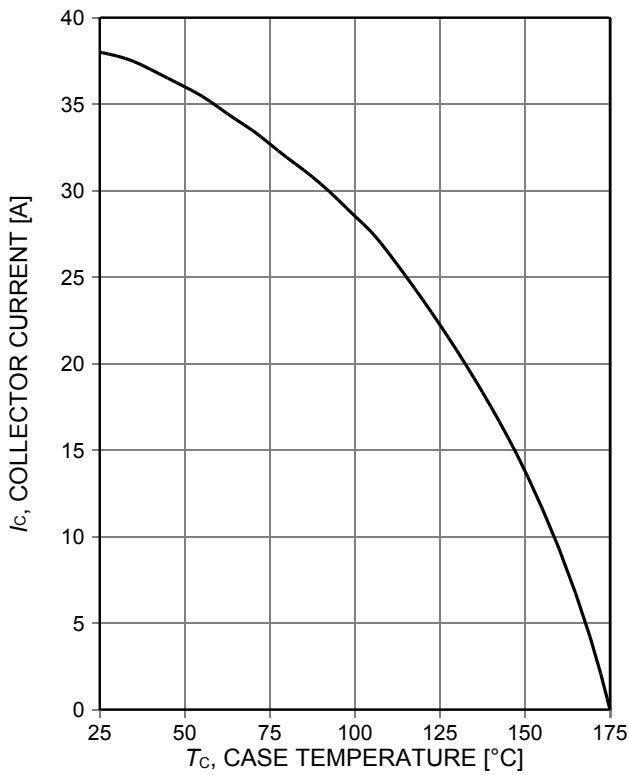


Figure 2. Collector current as a function of case temperature  
 $(V_{GE} \geq 15\text{V}, T_{vj} \leq 175^\circ\text{C})$

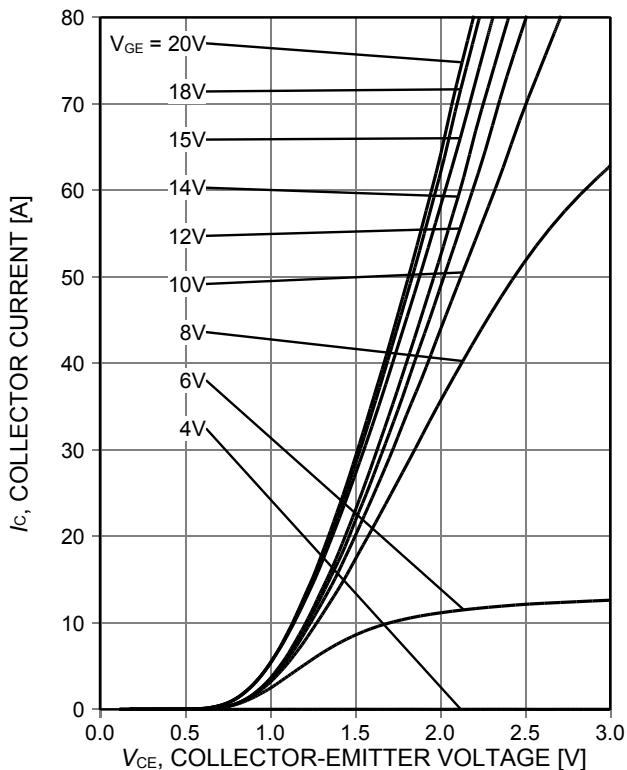


Figure 3. Typical output characteristic  
 $(T_{vj}=25^\circ\text{C})$

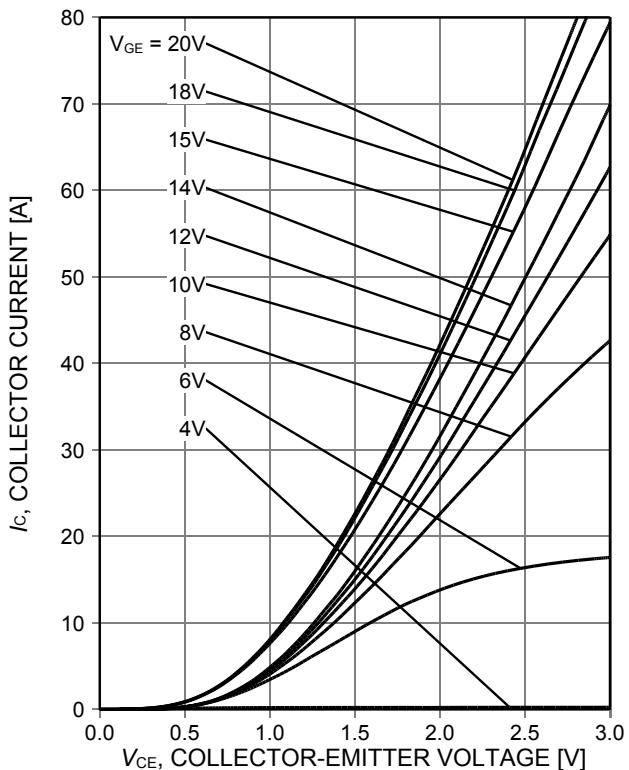


Figure 4. Typical output characteristic  
 $(T_{vj}=150^\circ\text{C})$

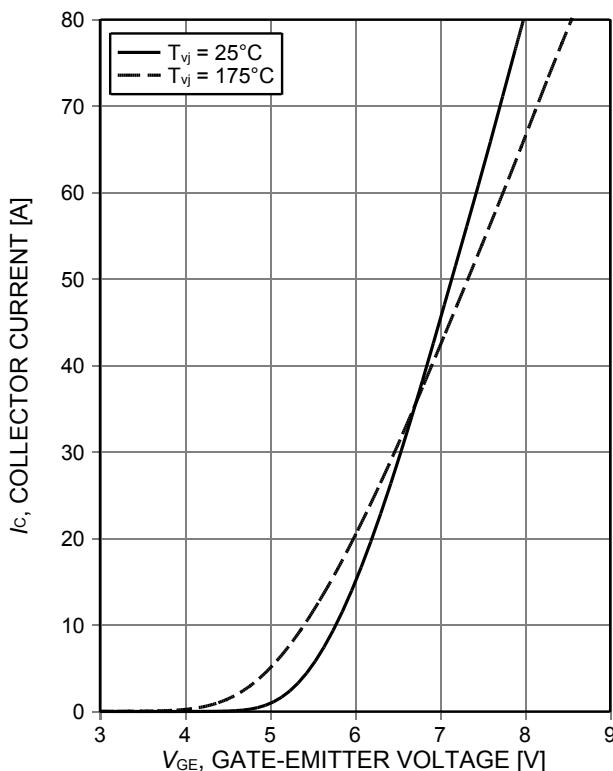
High speed switching series 5<sup>th</sup> generation

Figure 5. Typical transfer characteristic  
( $V_{CE}=20\text{V}$ )

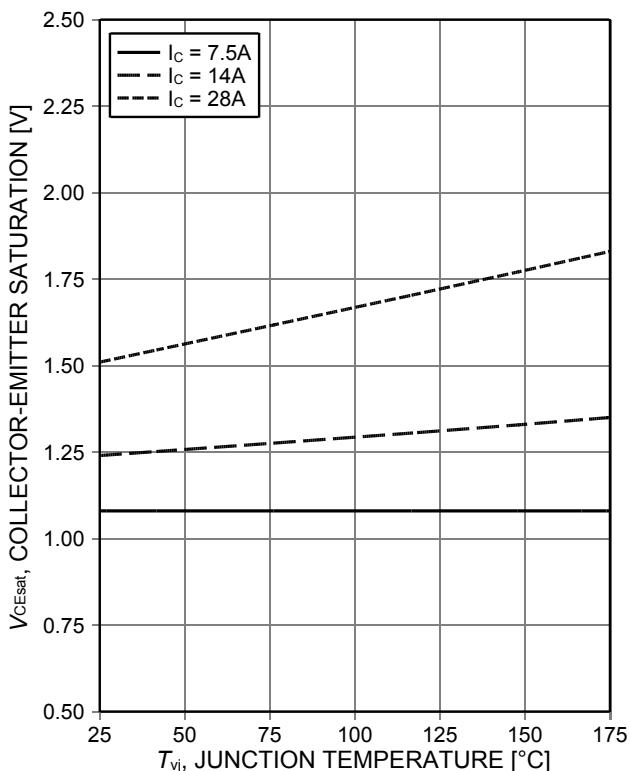


Figure 6. Typical collector-emitter saturation voltage as a function of junction temperature  
( $V_{GE}=15\text{V}$ )

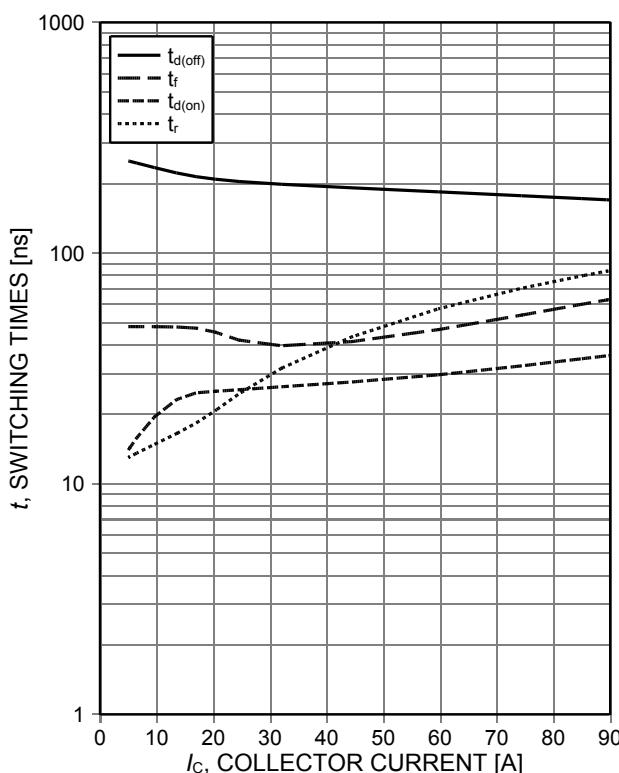


Figure 7. Typical switching times as a function of collector current  
(inductive load,  $T_{vj}=150^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  
 $V_{GE}=15/0\text{V}$ ,  $r_g=34\Omega$ , Dynamic test circuit in  
Figure E)

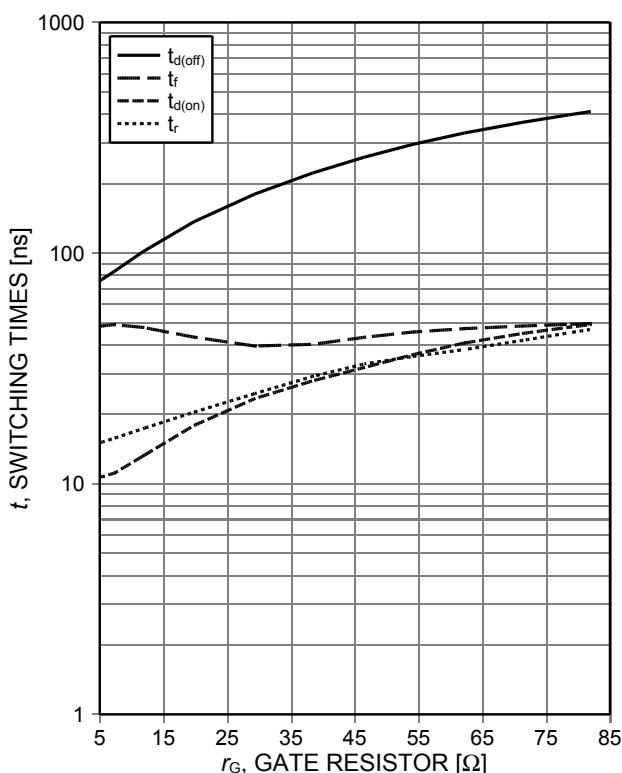
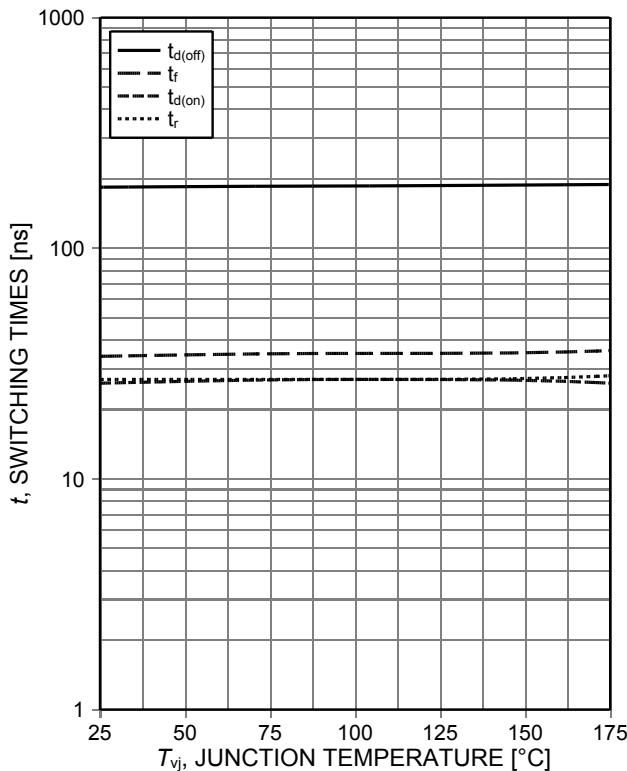
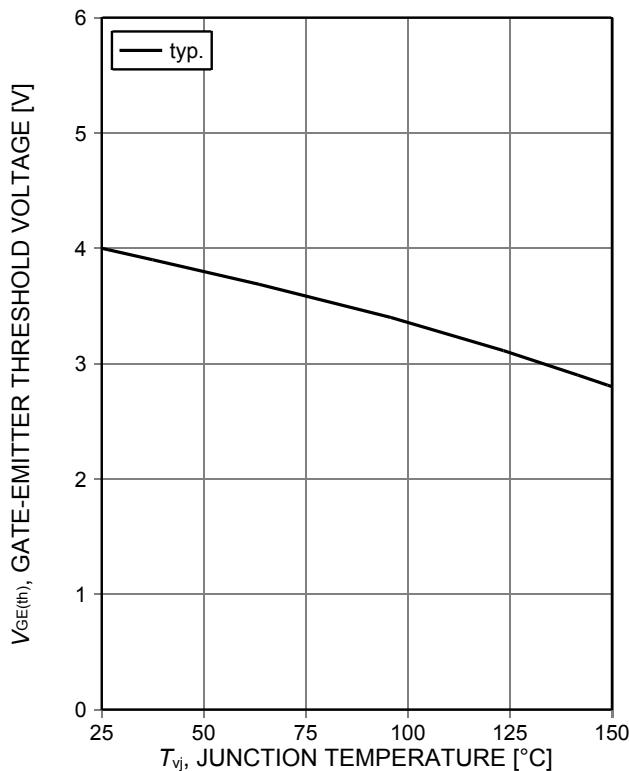


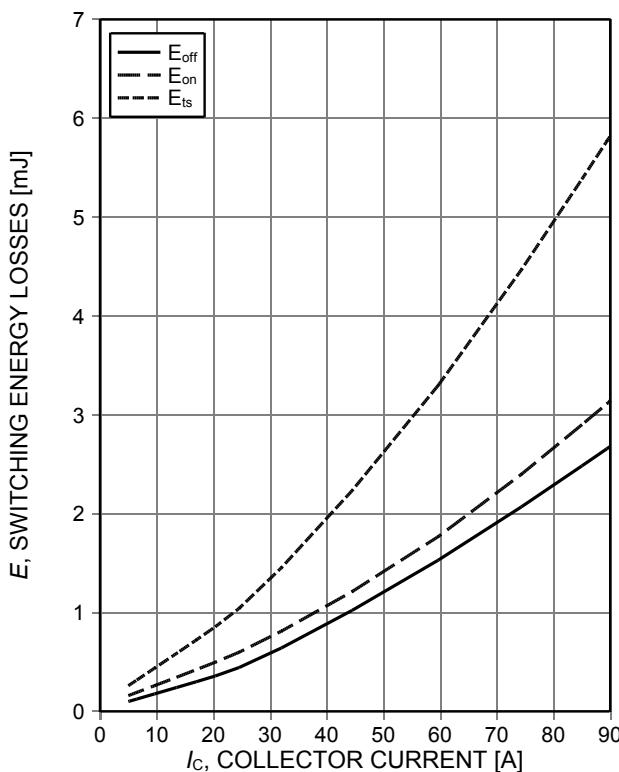
Figure 8. Typical switching times as a function of gate resistor  
(inductive load,  $T_{vj}=150^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  
 $V_{GE}=15/0\text{V}$ ,  $I_c=28\text{A}$ , Dynamic test circuit in  
Figure E)

High speed switching series 5<sup>th</sup> generation

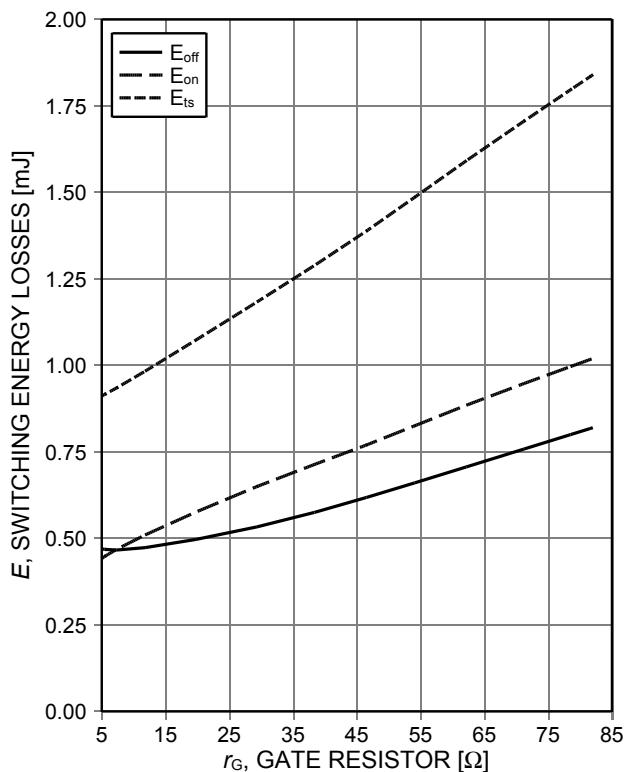
**Figure 9. Typical switching times as a function of junction temperature**  
(inductive load,  $V_{CE}=400V$ ,  $V_{GE}=15/0V$ ,  $I_C=28A$ ,  $r_G=34\Omega$ , Dynamic test circuit in Figure E)



**Figure 10. Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C=0.28mA$ )



**Figure 11. Typical switching energy losses as a function of collector current**  
(inductive load,  $T_{vj}=150^\circ C$ ,  $V_{CE}=400V$ ,  $V_{GE}=15/0V$ ,  $r_G=34\Omega$ , Dynamic test circuit in Figure E)



**Figure 12. Typical switching energy losses as a function of gate resistor**  
(inductive load,  $T_{vj}=150^\circ C$ ,  $V_{CE}=400V$ ,  $V_{GE}=15/0V$ ,  $I_C=28A$ , Dynamic test circuit in Figure E)

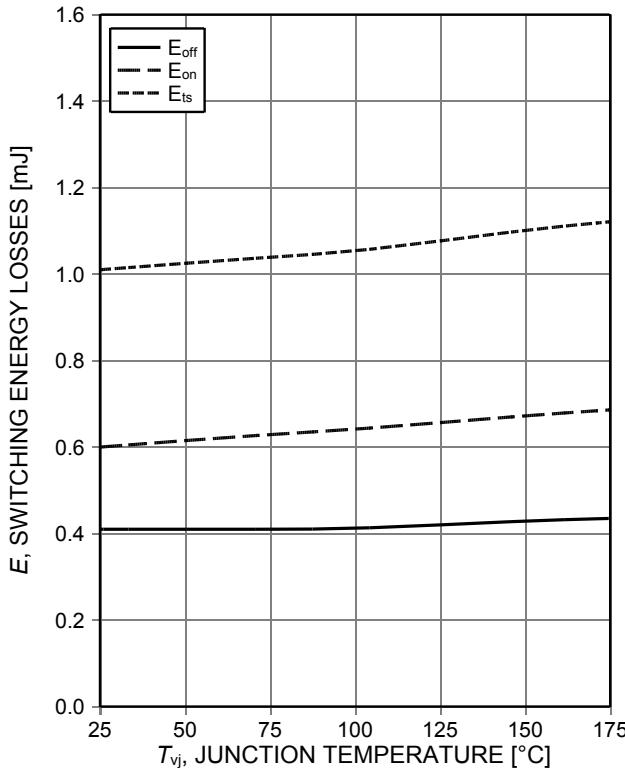
High speed switching series 5<sup>th</sup> generation

Figure 13. **Typical switching energy losses as a function of junction temperature**  
(inductive load,  $V_{CE}=400V$ ,  $V_{GE}=15/0V$ ,  $I_C=28A$ ,  $r_G=34\Omega$ , Dynamic test circuit in Figure E)

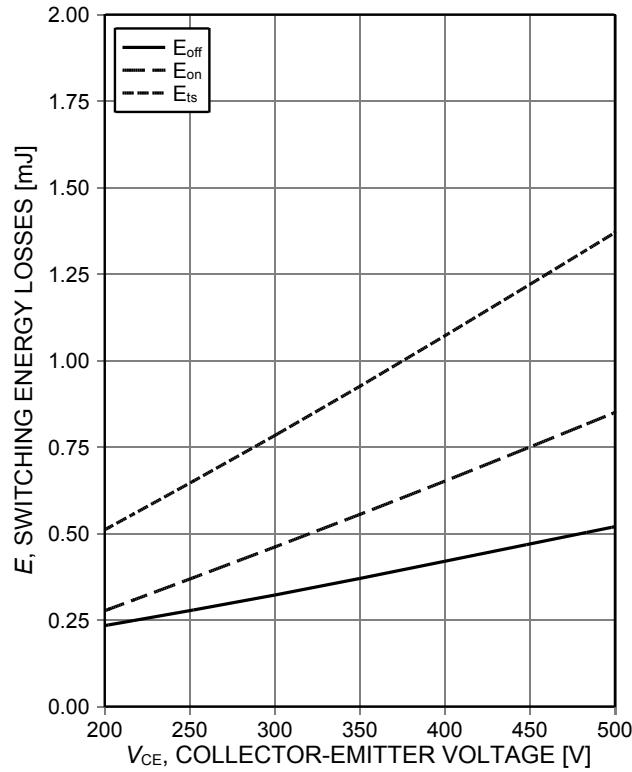


Figure 14. **Typical switching energy losses as a function of collector-emitter voltage**  
(inductive load,  $T_{vj}=150^{\circ}C$ ,  $V_{GE}=15/0V$ ,  $I_C=28A$ ,  $r_G=34\Omega$ , Dynamic test circuit in Figure E)

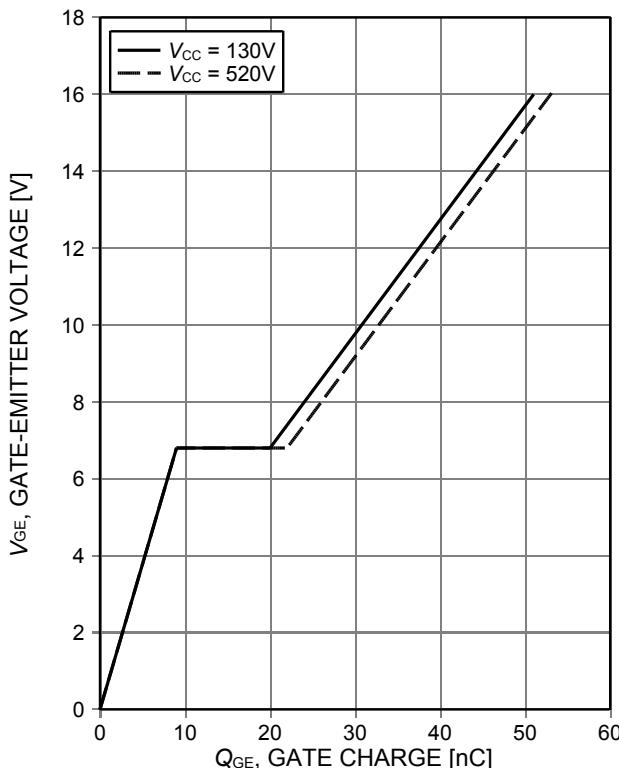


Figure 15. **Typical gate charge**  
( $I_C=28A$ )

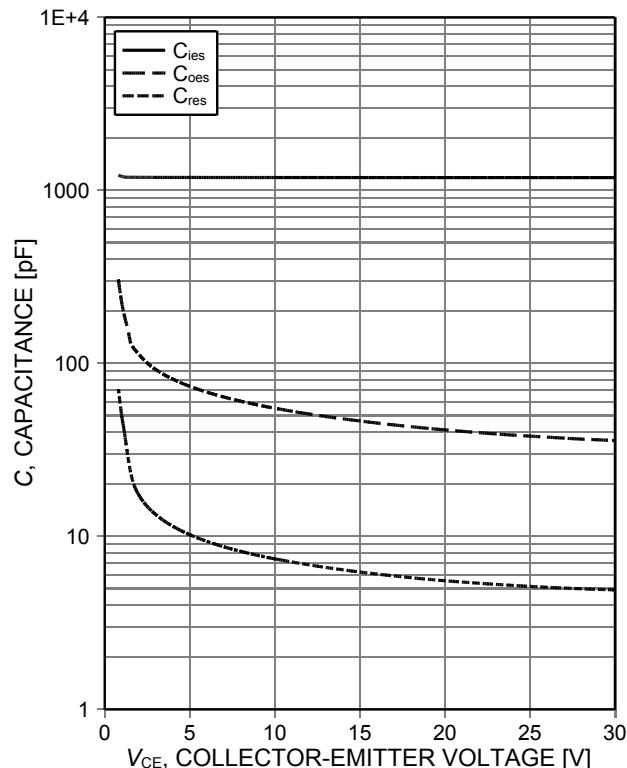
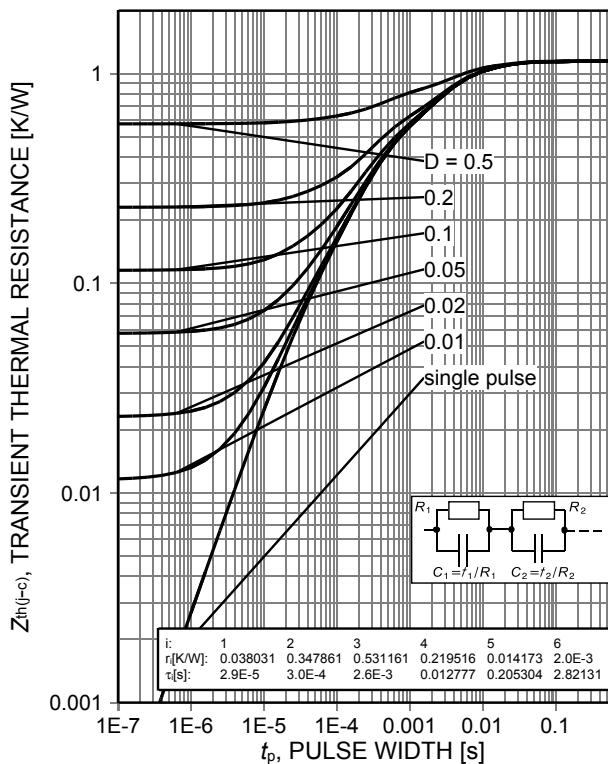
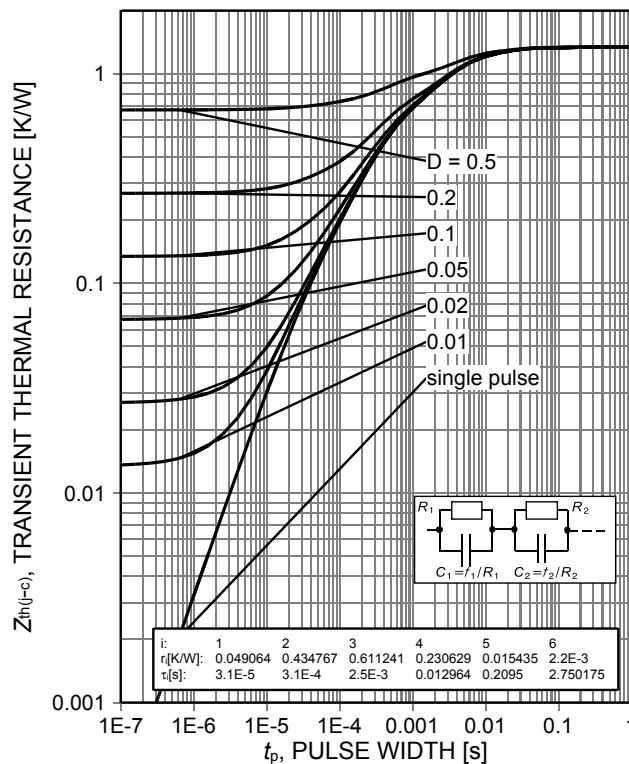
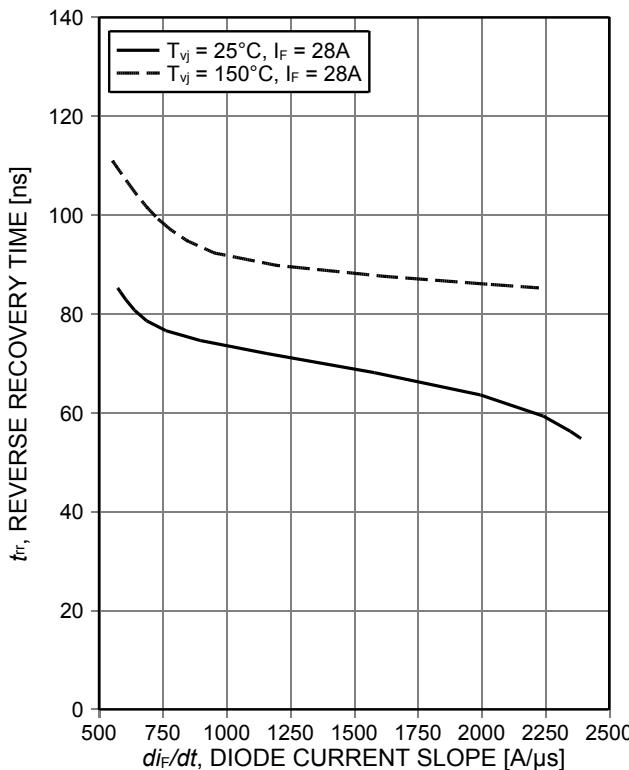
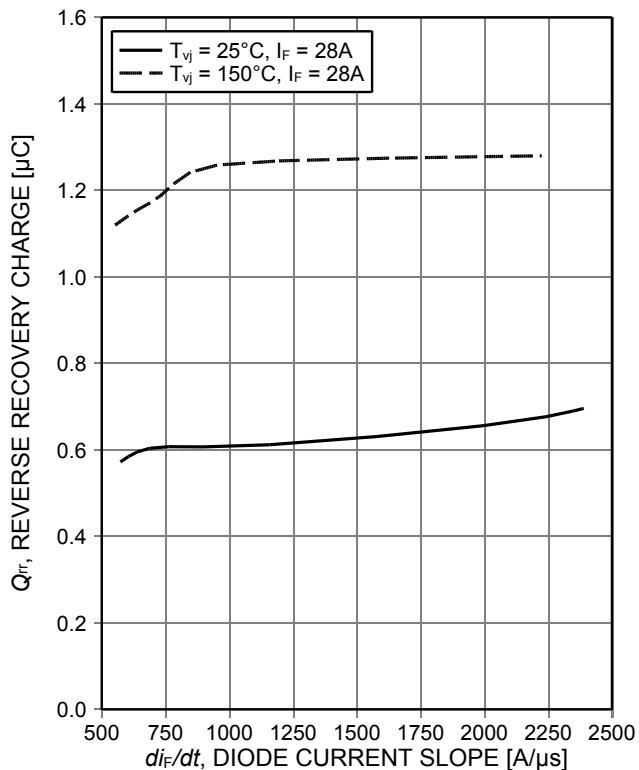


Figure 16. **Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE}=0V$ ,  $f=1MHz$ )

High speed switching series 5<sup>th</sup> generationFigure 17. IGBT transient thermal resistance  
( $D=t_p/T$ )Figure 18. Diode transient thermal impedance as a function of pulse width  
( $D=t_p/T$ )Figure 19. Typical reverse recovery time as a function of diode current slope  
( $V_R=400\text{V}$ )Figure 20. Typical reverse recovery charge as a function of diode current slope  
( $V_R=400\text{V}$ )

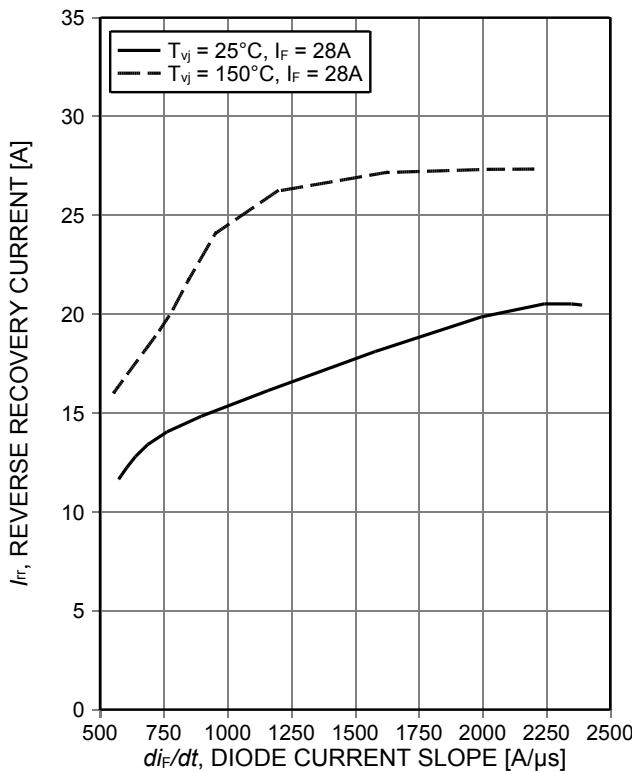
High speed switching series 5<sup>th</sup> generation

Figure 21. Typical reverse recovery current as a function of diode current slope ( $V_R=400\text{V}$ )

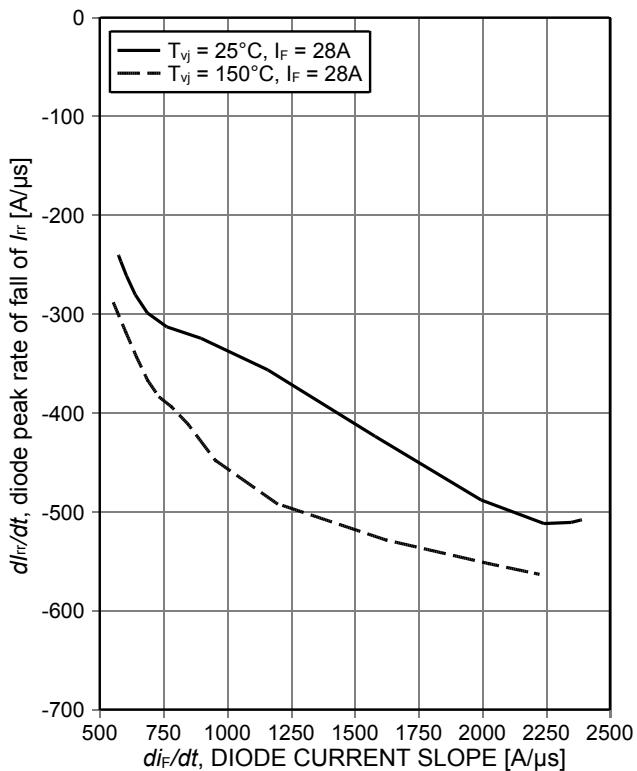


Figure 22. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope ( $V_R=400\text{V}$ )

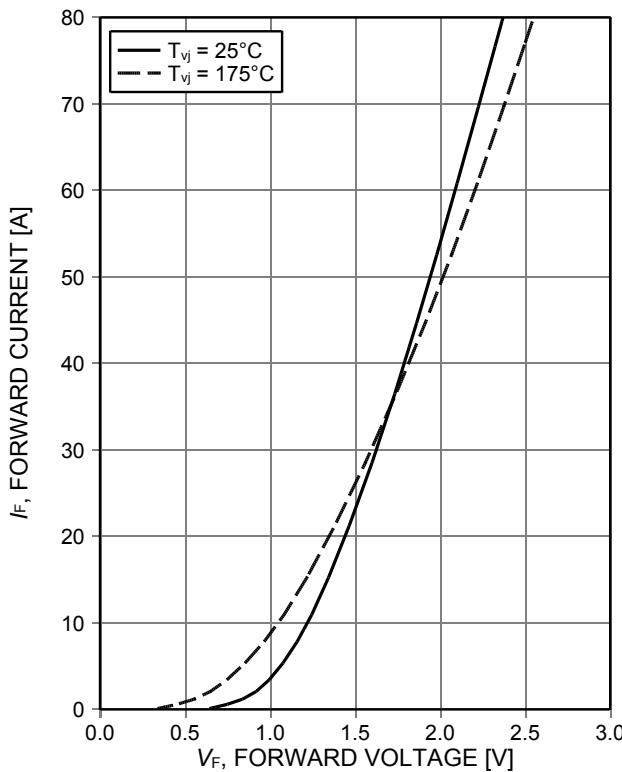


Figure 23. Typical diode forward current as a function of forward voltage

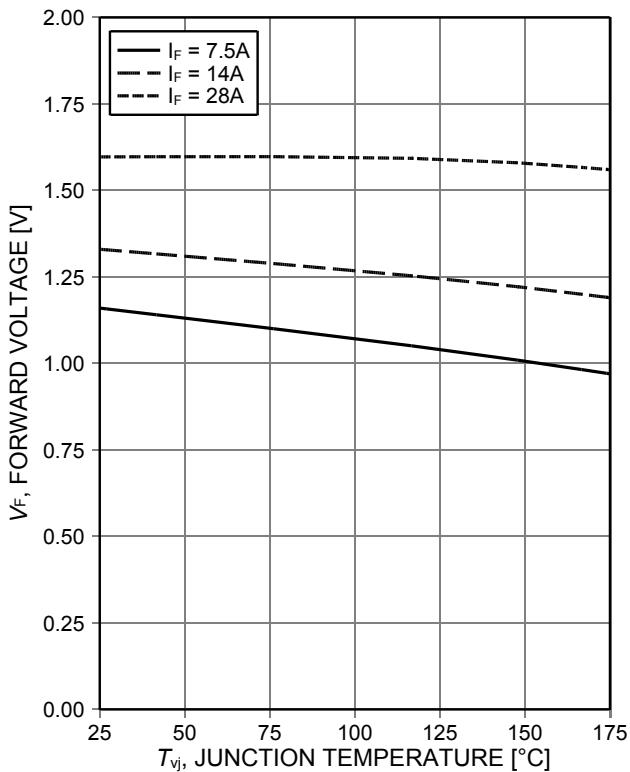
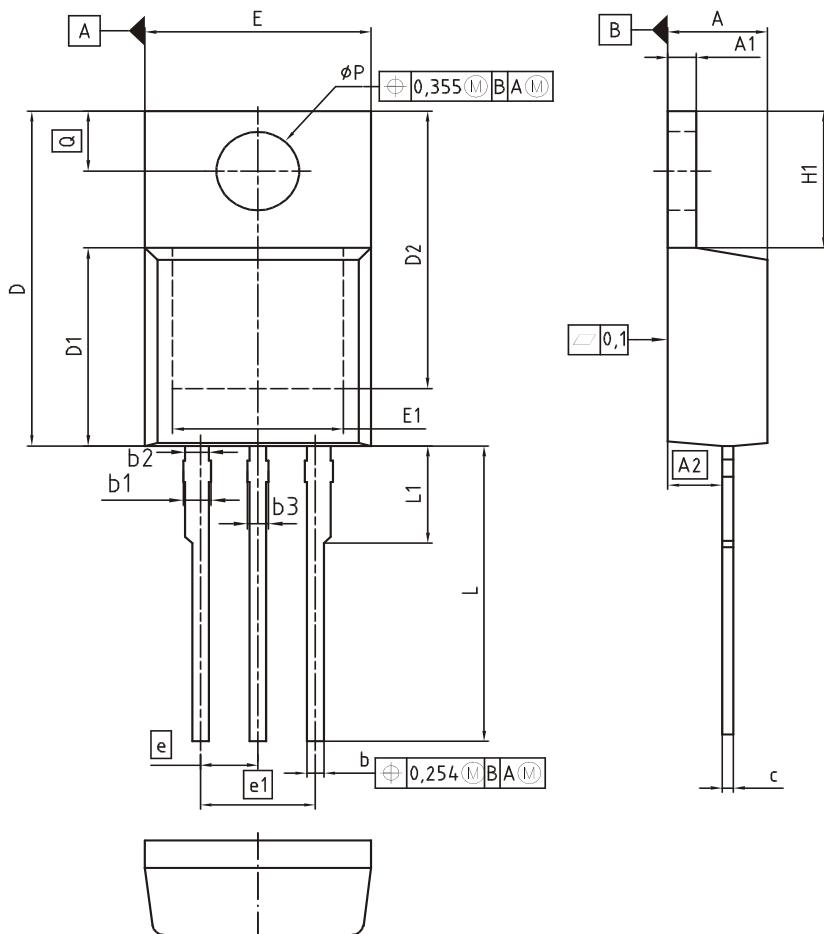


Figure 24. Typical diode forward voltage as a function of junction temperature

High speed switching series 5<sup>th</sup> generation

### Package Drawing PG-T0220-3



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	1.17	1.40	0.046	0.055
A2	2.15	2.72	0.085	0.107
b	0.65	0.86	0.026	0.034
b1	0.95	1.40	0.037	0.055
b2	0.95	1.15	0.037	0.045
b3	0.65	1.15	0.026	0.045
c	0.33	0.60	0.013	0.024
D	14.81	15.95	0.583	0.628
D1	8.51	9.45	0.335	0.372
D2	12.19	13.10	0.480	0.516
E	9.70	10.36	0.382	0.408
E1	6.50	8.60	0.256	0.339
e	2.54		0.100	
e1	5.08		0.200	
N	3		3	
H1	5.90	6.90	0.232	0.272
L	13.00	14.00	0.512	0.551
L1	-	4.80	-	0.189
ØP	3.60	3.89	0.142	0.153
Q	2.60	3.00	0.102	0.118

DOCUMENT NO.	Z8B00003318
SCALE	0 2.5 0 2.5 5mm
EUROPEAN PROJECTION	
ISSUE DATE	30-07-2009
REVISION	06

High speed switching series 5<sup>th</sup> generation

## Testing Conditions

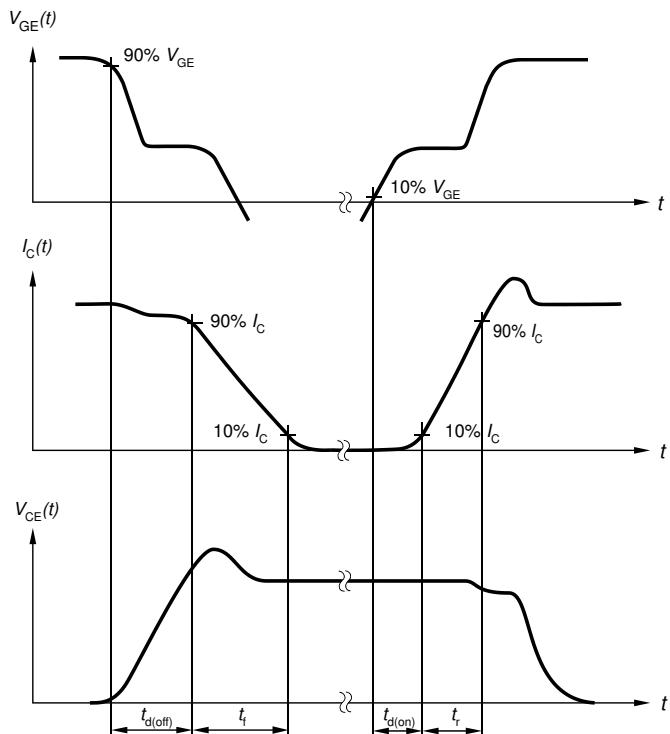


Figure A. Definition of switching times

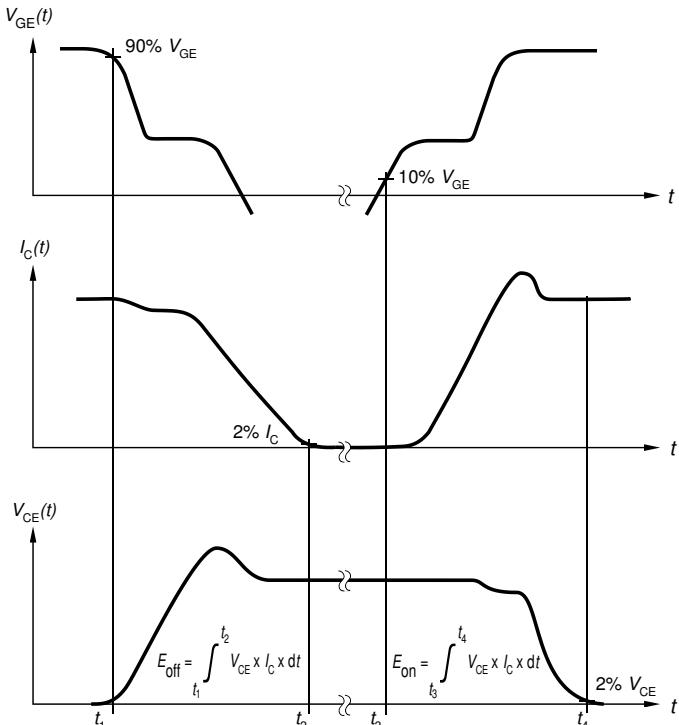


Figure B. Definition of switching losses

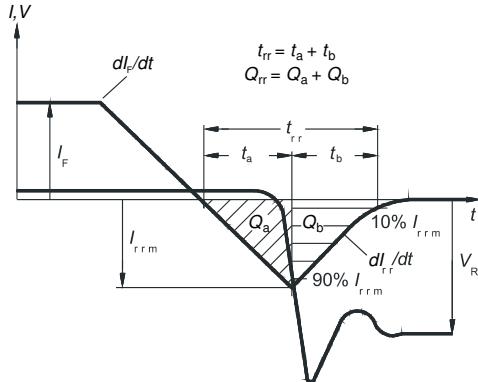


Figure C. Definition of diode switching characteristics

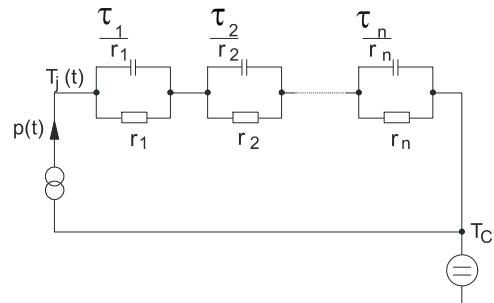


Figure D. Thermal equivalent circuit

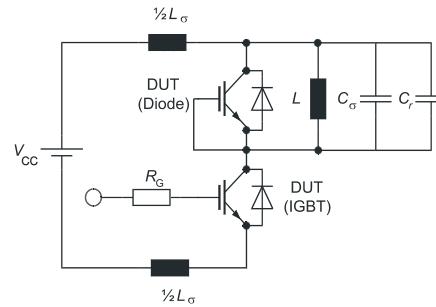


Figure E. Dynamic test circuit  
 Parasitic inductance  $L_\sigma$ ,  
 parasitic capacitor  $C_\sigma$ ,  
 relief capacitor  $C_r$ ,  
 (only for ZVT switching)

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High speed switching series 5<sup>th</sup> generation

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**Revision History**

IKP28N65ES5

**Revision: 2019-01-25, Rev. 2.1**

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.1	2019-01-25	Final data sheet

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